Parallel Accelerators

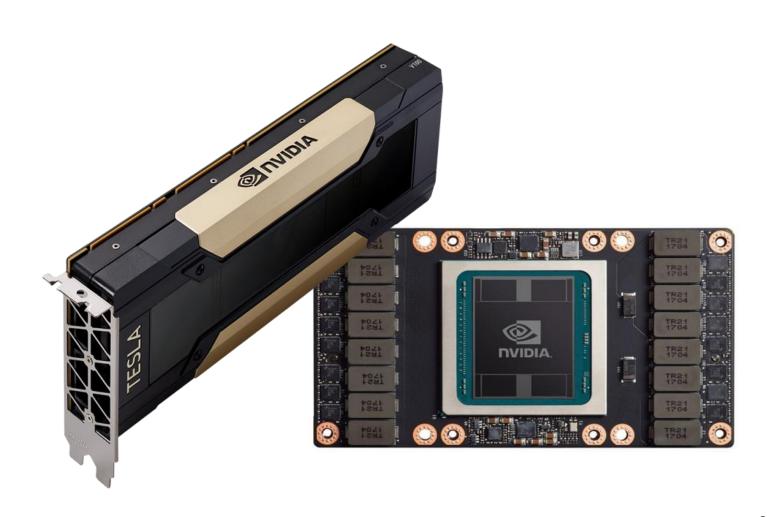
Přemysl Šůcha

"Parallel algorithms", 2017/2018
CTU/FEL

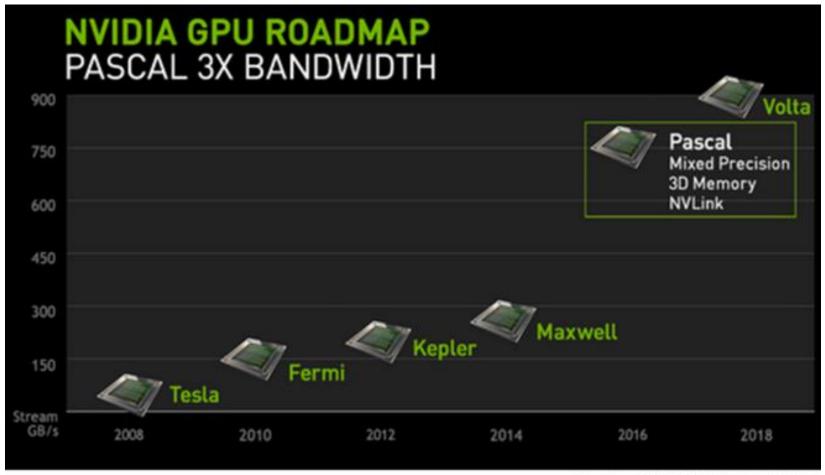
Topic Overview

- Graphical Processing Units (GPU) and CUDA
- Vector addition on CUDA
- Intel Xeon Scalable Processors

Graphical Processing Units



GPU – Nvidia - Roadmap



Market Realist^Q

Source: NVIDIA's Presentation

GPU - Use

- GPU is especially well-suited to address problems that can be expressed as **data-parallel computations**.
- The same program is executed on many data elements in parallel - with high arithmetic intensity.
- Applications that process large data sets can use a data-parallel programming model to speed up the computations (3D rendering, image processing, video encoding, ...)
- Many algorithms outside the field of image rendering and processing are accelerated by data-parallel processing too (machine learning, general signal processing, physics simulation, finance, ...).

GPU - Overview

- CPU code runs on the host, GPU code runs on the device.
- A kernel consists of multiple threads.
- Threads execute in 32-thread groups called warps.
- Threads are grouped into blocks.
- A collection of blocks is called a grid.

GPU - Hardware Organization Overview

- GPU chip consists of one or more streaming multiprocessors (SM).
- A multiprocessor consists of 1 (CC 1.x), 2 (CC 2.x), or 4 (CC 3.x, 5.x, 6.x, 7.x) warp schedulers. (CC = CUDA Capability)
- Each warp scheduler can issue to 2 (CC 5 and 6) or 1 (CC 7) dispatch units.
- A multiprocessor consists of functional units of several types.

Streaming Multiprocessor (SM) - Volta



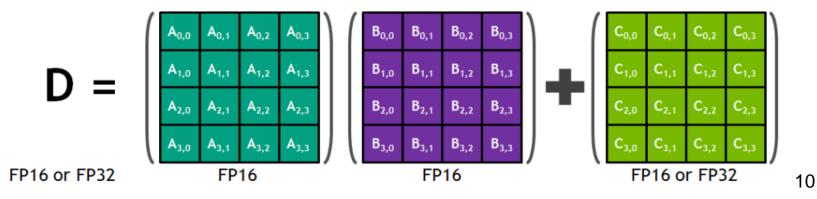


GPU - Functional Units

- INT, FP32 (CUDA Core) functional units that executes most types of instructions, including most integer and single precision floating point instructions.
- FP64 (Double Precision) executes double-precision floating point instructions.
- SFU (Special Functional Unit) executes reciprocal and transcendental instructions such as sine, cosine, and reciprocal square root.
- LD/ST (Load/Store Unit) handles load and store instructions.
- TENSOR CORE for deep learning matrix arithmetic.

GPU - Tensor Core

- V100 GPU contains 640 Tensor Cores: eight (8) per SM.
- Tensor Core performs 64 floating point FMA (fused multiply–add) operations per clock.
- Matrix-Matrix multiplication (GEMM) operations are at the core of neural network training and inferencing.
- Each Tensor Core operates on a 4x4 matrices.



Streaming Multiprocessor (SM)

- Each SM has a set of temporary registers split amongst threads.
- Instructions can access high-speed shared memory.
- Instructions can access a cache-backed constant space.
- Instructions can access local memory.
- Instructions can access global space. (very slow in general)

GPU Architecture - Volta



GPU Architectures

Tesla Product	Tesla K40	Tesla M40	Tesla P100	Tesla V100
Manufacturing Process	28nm	28nm	16nm	12nm
Transistors	7.1 Billion	8.0 Billion	15.3 Billion	21.1 Billion
SMs / GPU	15	24	28	40
F32 Cores / SM	192	128	64	64
F32 Cores / GPU	2880	3072	3584	5120
Peak FP32 TFLOPS	5	6.8	10.6	15.7
Peak FP64 TFLOPS	1.7	0,21	5.3	7.8
GPU Boost Clock	810/870 MHz	1114 MHz	1480 MHz	1530 MHz
TDP	235 W	250 W	300 W	300 W
Memory Interface	384-bit GDDR5	384-bit GDDR5	4096-bit HBM2	4096-bit HBM2
Maximum TDP	244W	250W	250W	300W

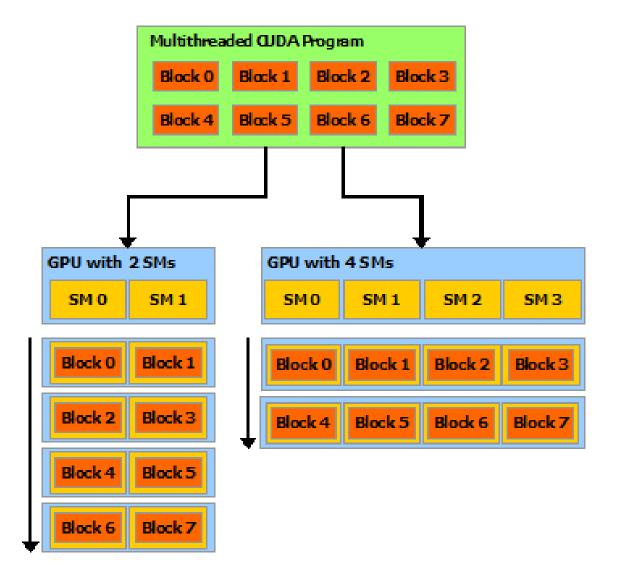
Single-Instruction, Multiple-Thread

- SIMT is an execution model where single instruction, multiple data (SIMD) is combined with multithreading.
- The SM creates, manages, schedules, and executes threads in groups of 32 parallel threads called warps.
- A warp start together at the same program address, but they have their own instruction address counter and register state and are therefore free to branch and execute independently.

CUDA

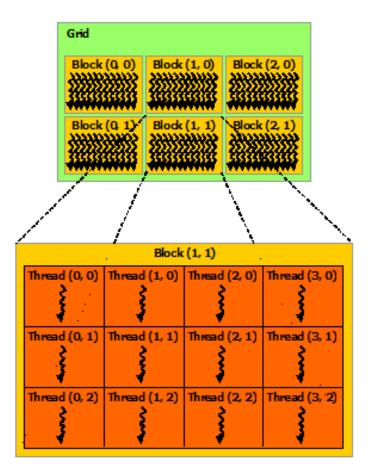
- The NVIDIA GPU architecture is built around a scalable array of multithreaded Streaming Multiprocessors (SMs).
- CUDA (Compute Unified Device Architecture) provides a way how a CUDA program can be executed on any number of SMs.
- A multithreaded program is partitioned into blocks of threads that execute independently from each other.
- A GPU with more multiprocessors will automatically execute the program in less time than a GPU with fewer multiprocessors.

CUDA



Grid/Block/Thread

- threads can be identified using a 1-D, 2-D, or 3-D thread index, forming a 1-D, 2-D, or 3-D block of threads, called a thread block.
- Blocks are organized into a 1-D, 2-D, or 3-D grid of thread blocks.



2-D grid with 2-D thread blocks

Kernel

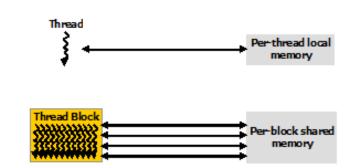
 CUDA C extends C by allowing the programmer to define C functions, called kernels.

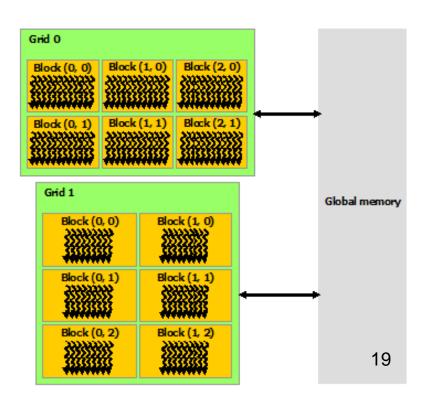
```
// Kernel definition
__global__ void VecAdd(float* A, float* B, float* C)
{
         int i = threadIdx.x;
         C[i] = A[i] + B[i];
}
int main()
{ ...
         // Kernel invocation with N threads inside 1 thread block
         VecAdd<<<1, N>>>(A, B, C);
}
```

 threadIdx is a 3-component vector, so that threads can be identified using a 1-D, 2-D, or 3-D thread index.

Memory Hierarchy

- Each thread has private set of registers and local memory.
- Each thread block has shared memory visible to all threads of the block.
- All threads have access to the same global memory.
- There are also two
 additional read-only
 memory spaces accessible
 by all threads (constant
 and texture memory).





GPU Programming - Example

Element by element vector addition

[1] NVIDIA Corporation, *CUDA Toolkit Documentation v9.0.176*, 2017.

```
/* Host main routine */
int main(void)
{
    int numElements = 50000;
    size t size = numElements * sizeof(float);
    // Allocate the host input vectors A and B and output vector C
    float *h A = (float *)malloc(size);
    float *h B = (float *)malloc(size);
    float *h C = (float *)malloc(size);
    // Initialize the host input vectors
    for (int i = 0; i < numElements; ++i)</pre>
    {
        h A[i] = rand()/(float)RAND MAX;
        h B[i] = rand()/(float)RAND MAX;
    }
```

```
// Allocate the device input vectors A and B and output vector C
float *d_A = NULL;
cudaMalloc((void **)&d_A, size);
float *d_B = NULL;
cudaMalloc((void **)&d_B, size);
float *d_C = NULL;
cudaMalloc((void **)&d_C, size);

// Copy the host input vectors A and B in host memory to the device
// input vectors in device memory
cudaMemcpy(d_A, h_A, size, cudaMemcpyHostToDevice);
cudaMemcpy(d_B, h_B, size, cudaMemcpyHostToDevice);
```

```
// Launch the Vector Add CUDA Kernel
int threadsPerBlock = 256;
int blocksPerGrid = (numElements + threadsPerBlock - 1) / threadsPerBlock;

vectorAdd<<<blooksPerGrid, threadsPerBlock>>>(d_A, d_B, d_C, numElements);

// Copy the device result vector in device memory to the host result vector
// in host memory.

cudaMemcpy(h_C, d_C, size, cudaMemcpyDeviceToHost);
```

```
// Free device global memory
err = cudaFree(d_A);
err = cudaFree(d_B);
err = cudaFree(d_C);

// Free host memory
free(h_A);
free(h_B);
free(h_C);
```

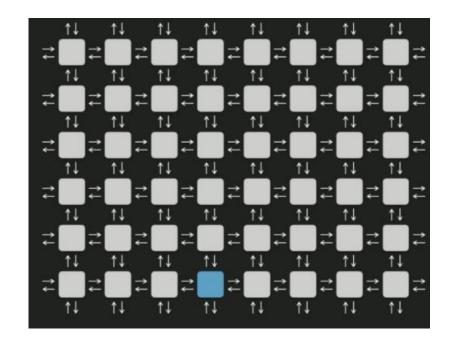
```
/**
 * CUDA Kernel Device code
 *
 * Computes the vector addition of A and B into C. The 3 vectors have the same
 * number of elements numElements.
 */
 global void vectorAdd(float *A, float *B, float *C, int numElements)
    int i = blockDim.x * blockIdx.x + threadIdx.x;
    if (i < numElements)</pre>
        C[i] = A[i] + B[i];
}
```

Tesla's Al chip



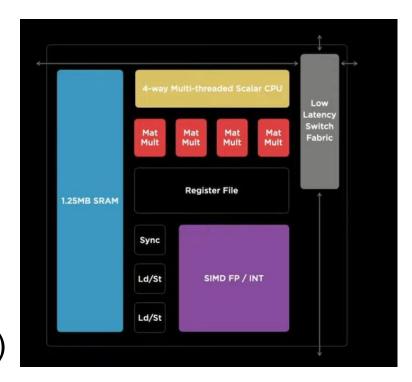
Dojo architecture

- The achitecture is focused on ML
- Dojo is based on a custom computing chip, the D1 chip, which is the building block of a large multi-chip module (MCM)-based compute plane
- Training nodes are interconned via a 2D mesh

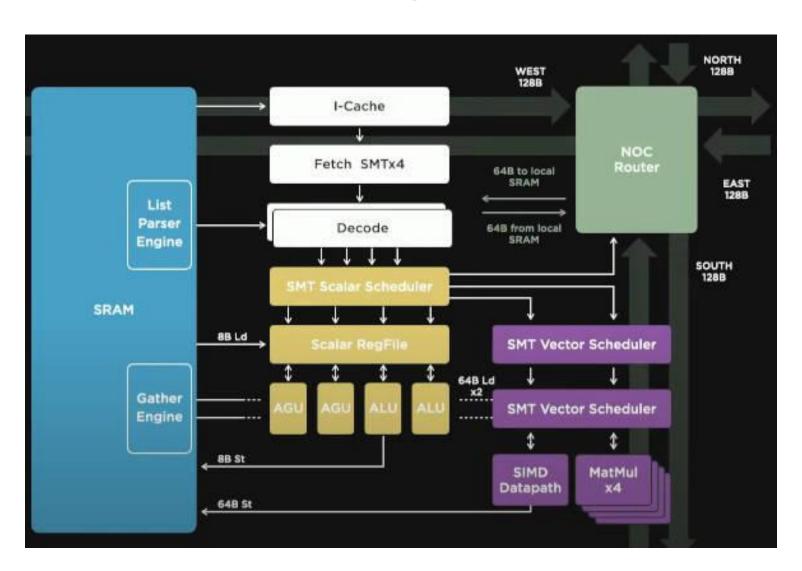


Training node

- The smallest entity is a training node
- 64-bit CPU (2GHz) fully optimized for machine learning workloads
- 1.25 MB of fast ECC-protected SRAM
- optimized matrix multiply units and SIMD instructions (FP32, BFP16, CFP8, Int32, Int16, Int8)
- 1 teraflop of ML compute
- The training node has a modular design

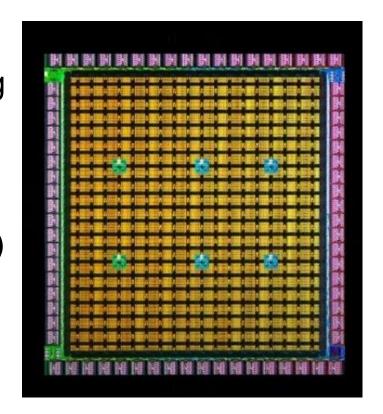


Training node



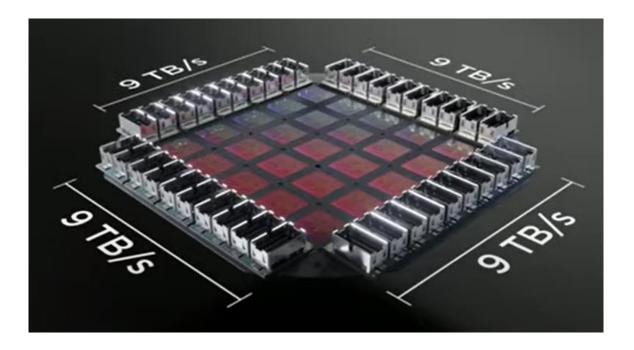
The D1 Chip

- created by an array of 354 training nodes
- 362 teraflops of machine learning compute
- the bandwidth for the communications between the training nodes (on-chip bandwidt) is 10 TBps (4 TBps off-chip).
- D1 is manufactured in 7 nm technology
- The thermal design power (TDP) of the chip is 400 W.

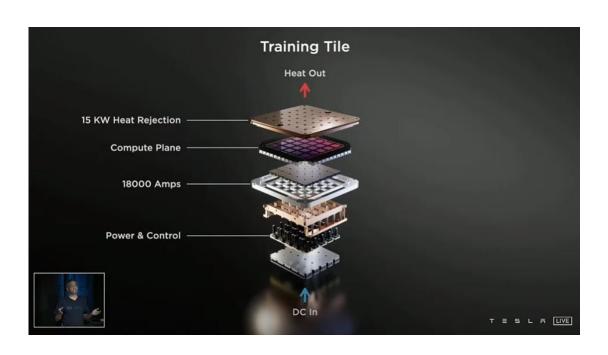


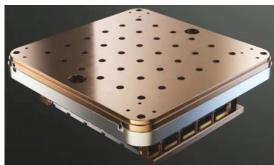
Dojo's Training Tiles

- consisting of 25 D1 chips (5 x 5)
- bandwidth between the dies is preserved
- D1 chips can consume 10 kW
- 9 PFLOPs



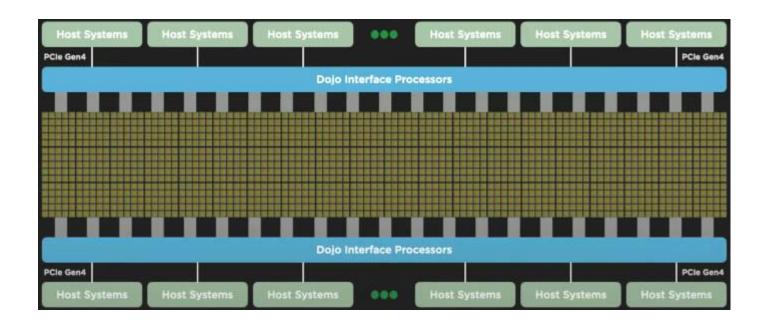
Dojo's Training Tiles





Al supercomputer

Aim is to achieve 1.1EFLOPs in ML



Logical view

- DPU Dojo Processing Unit
- A virtual device that can be sized according to the application needs



References

 Tesla's AI chip REVEALED! (Project Dojo), presented at Tesla AI Day

(https://www.youtube.com/watch?v=DSw3IwsgNnc)